

Specification Sheet for Approved

| | |
|--------------------|-----------------|
| Customer Name: | |
| Customer Part No.: | |
| Ceaiya Part No: | CMPI0624 Series |
| Spec No: | L0624 |

【For Customer Approval Only】

If you Approval, Please Stamp

【RoHS Compliant Parts】

| Approved By | Checked By | Prepared By |
|-------------|------------|-------------|
| 李庆辉 | 苏高峰 | 劳水花 |

Shenzhen Ceaiya Electronics Co., Ltd.

地址 1: 深圳市龙华区观湖街道鹭湖社区观盛二路 5 号捷顺科技中心 B706

地址 2: 东莞清溪镇青滨东路 105 号力合紫荆智能制造中心 10 栋

Http : //www.szceaiya.com

Tel: 0769-89333213

Specification Sheet for SMD Power Inductor

1. Scope

This specification applies to the CMPI0624 Series of wire wound SMD power inductor.

2. Product Description and Identification (Part Number)

1) Description:

CMPI0624 series of Wire wound SMD power inductor.

2) Product Identification (Part Number)

CMPI 0624 - R68 M
 ① ② ③ ④

① Product Series

② ChokeSize

③ InitialInductance(L@ 0A):1R0=1.0μH

④ InductanceTolerance:M= ± 20%

3. Electrical Characteristics

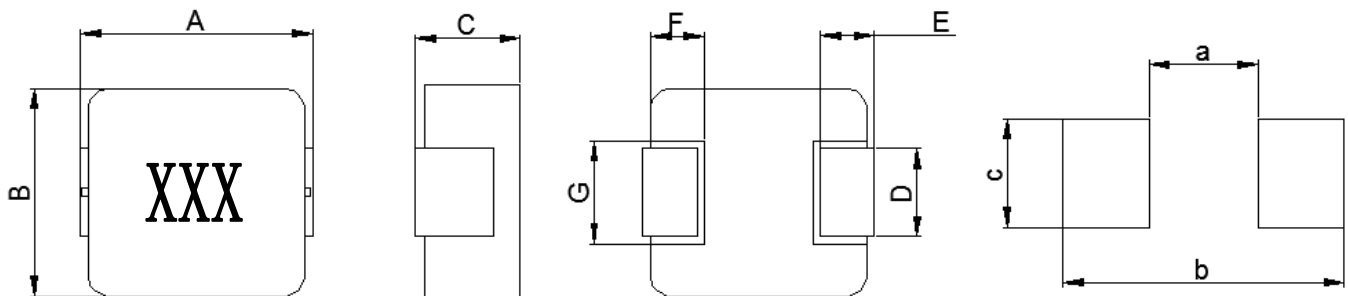
1) Operating temperature range (individual chip without packing): -40°C ~ +125°C (Including Self-heating) .

2) Storage temperature range (On PCB): -40°C ~ +125°C

4. Shape and Dimensions (Unit:mm)

Mechanical Parameters

Recommended PCB Layout



| A | B | C | D | E | F | G | a | b | c |
|-------|-------|-----|-------|-------|------|------|------|------|------|
| 7.10 | 6.60 | 2.5 | 3.00 | 1.60 | 2.00 | 3.60 | 3.70 | 8.40 | 3.50 |
| ±0.30 | ±0.20 | Max | ±0.30 | ±0.30 | Typ. | Typ. | Typ. | Typ. | Typ. |

Notes:

1. Marking :Ink Marking
2. Stamping XXX :inductor
3. Dimensions of recommended PCB layout are reference only.
4. Do not route traces or place vias underneath the inductor. Proper layout is required.

Specification Sheet for SMD Power Inductor

5. Electrical Characteristics

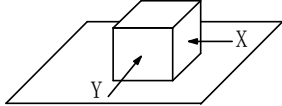
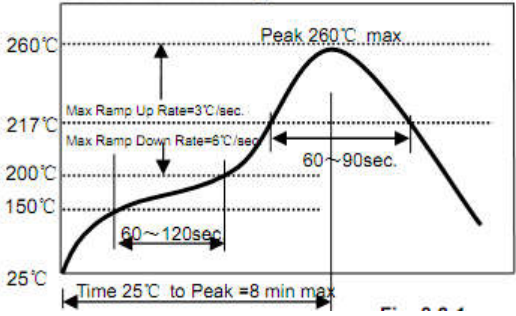
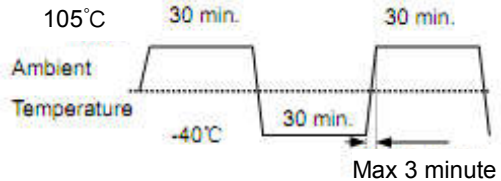
| Part Number | L0(uH) ±20% | DCR(mΩ) @25°C | | Isat(Amp) Typ. | Irms(Amp) Typ. |
|----------------|----------------|------------------|------|-------------------|-------------------|
| | | Max. | Typ. | | |
| CMPI0624-R22M | 0.22 | 3.0 | 2.5 | 34.0 | 21.0 |
| CMPI0624-R33M | 0.33 | 4.1 | 3.5 | 24.5 | 18.0 |
| CMPI0624-R47M | 0.47 | 5.1 | 4.5 | 22.0 | 15.0 |
| CMPI0624-R56M | 0.56 | 6.5 | 5.5 | 17.0 | 13.0 |
| CMPI0624-R68M | 0.68 | 7.5 | 6.5 | 16.0 | 12.0 |
| CMPI0624-1R0M | 1.0 | 15.0 | 13.5 | 16.0 | 9.0 |
| CMPI0624-1R5M | 1.5 | 20 | 17 | 13.5 | 9.0 |
| CMPI0624--2R2M | 2.2 | 28 | 23 | 10.0 | 7.0 |
| CMPI0624-3R3M | 3.3 | 39 | 32 | 8.5 | 5.5 |
| CMPI0624-4R7M | 4.7 | 55 | 45 | 7.5 | 5.0 |
| CMPI0624-5R6M | 5.6 | 65 | 55 | 6.8 | 4.6 |
| CMPI0624-6R8M | 6.8 | 70 | 62 | 6.0 | 4.0 |
| CMPI0624-100M | 10 | 101 | 92 | 4.0 | 3.1 |
| CMPI0624-150M | 15 | 160 | 145 | 3.3 | 2.5 |

Notes:

1. InitialInductance(L0)TestParameters:100KHz,1V,I_{dc}=0.0A,+25°C
2. All test data is referenced to 25°C ambient;
3. Rated current: Isat or Irms, whichever is smaller;
4. Isat(A):DC current at which the inductance drops approximate 30% from its value without current;
5. Irms(A):DC current that causes the temperature rise ($\Delta T = 40^\circ \text{C}$) from 25° C ambient.

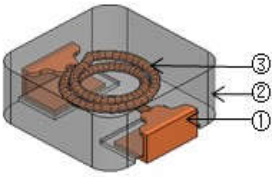
Specification Sheet for SMD Power Inductor

6. Reliability Test

| Items | Requirements | Test Methods and Remarks |
|--|---|---|
| 6.1 Terminal Strength | No removal or split of the termination or other defects shall occur.  Fig.6.1-1 | 1) Solder the inductor to the testing jig (glass epoxy board shown in Fig.6.1-1) using eutectic solder. Then apply a force in the direction of the arrow. 2) 10N force. 3) Keep time: 5±2s |
| 6.2 High Temperature | 1. No visible mechanical damage. 2. Inductance change: Within ±10% | 1) Storage Temperature :125+/-5°C 2) Duration : 96 ±4 Hours 3) Recovery : then measured at room ambient temperature after placing 24 hours. |
| 6.3 Low Temperature | 1. No visible mechanical damage 2. Inductance change: Within ±10% | 1) Temperature and time: -40±5°C 2) Duration: 96±4 hours 3) Recovery : then measured at room ambient temperature after placing 24 hours. |
| 6.4 Vibration test | 1. No visible mechanical damage. 2. Inductance change: Within ±10% | 1) Frequency range:10Hz~55Hz~10Hz 2) Amplitude:1.5mm p-p 3) Direction:X,Y,Z 4) Time:1 minute/cycle,2hours per axis |
| 6.5 High Temperature Storage Tested | 1. No visible mechanical damage. 2. Inductance change: Within ±10% | 1)Storage Temperature :60+/-2°C 2) Relative Humidity :90-95% 3) Duration : 96 ±4 Hours 4)Recovery : then measured at room ambient temperature after placing 24 hours. |
| 6.6 Resistance to Soldering Heat | 1. No visible mechanical damage. 2. Inductance change: Within ±10%  Fig.6.6-1 | 1) Re-flowing Profile: Please refer to Fig.6.6-1 2) Test board thickness: 1.0mm 3) Test board material: glass epoxy resin 4) The chip shall be stabilized at normal condition for 1~2 hours before measuring |
| 6.7 Thermal Shock | 1. No visible mechanical damage. 2. Inductance change: Within ±10%  Fig.6.7-1 | 1) Temperature and time: -40±3°C for 30±3 min→105°C for 30±3min, please refer to Fig.6.7-1. 2) Transforming interval: Max,3 minutes 3) Tested cycle: 100 cycles 4) The chip shall be stabilized at normal condition for 1~2 hours before measuring |

Specification Sheet for SMD Power Inductor

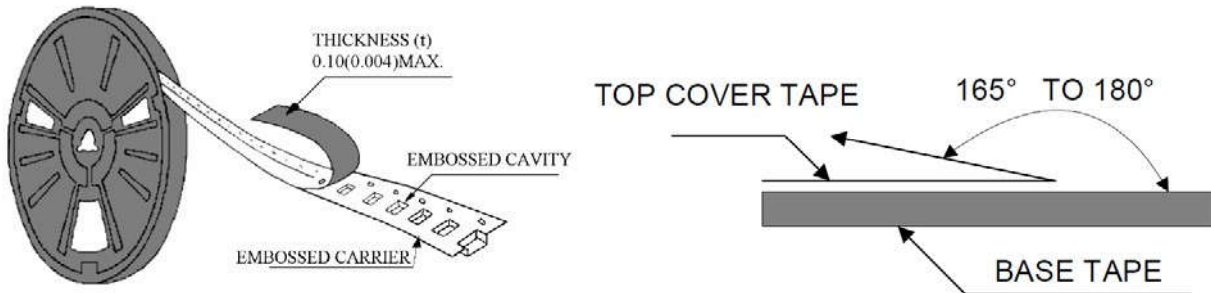
7. MATERIALLIST



| NO. | Part Name | Material |
|-----|-----------|--------------------|
| 1 | Electrode | Cu+Snplating |
| 2 | Core | Metalcompositecore |
| 3 | Coil | Copperwire,220°C |

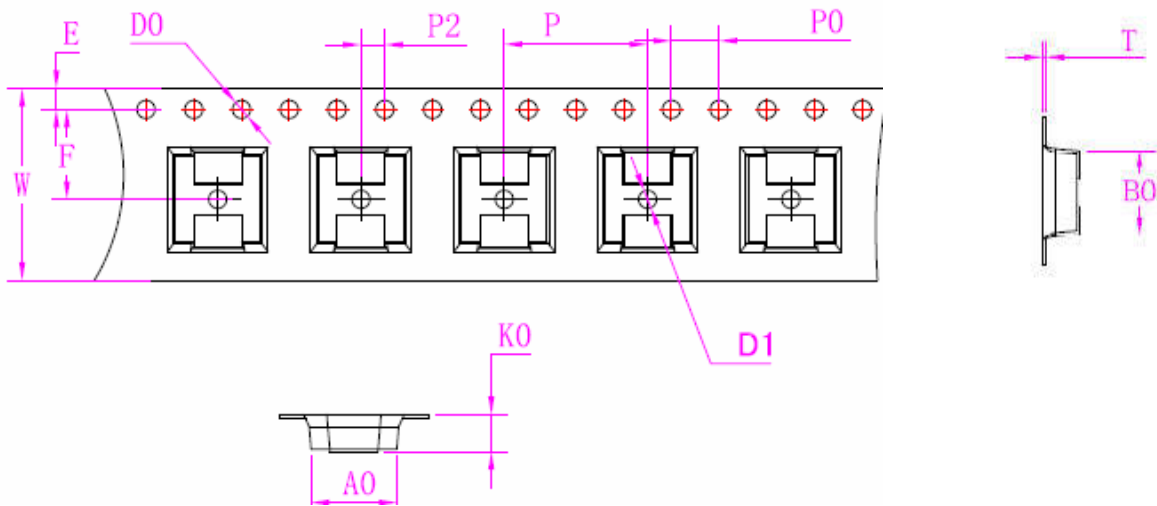
8. PACKAGE INFORMATION-mm

Peel-off Force



The force for peeling off cover tape is 30 to 100 grams in to arrow direction.

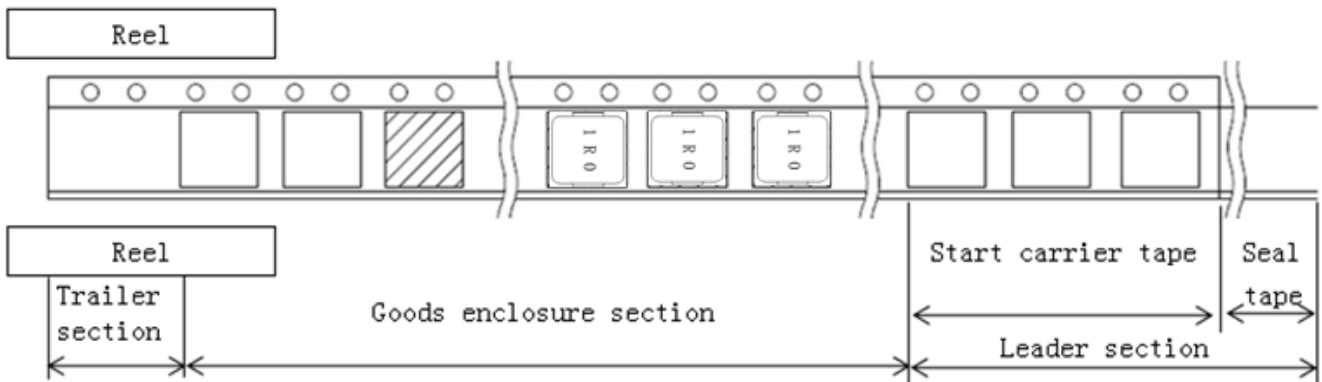
8.1 Tape Packaging Dimensions



| Item | W | A0 | B0 | K0 | P | F | E | D0 | D1 | P0 | P2 | T |
|------|------|------|------|------|------|------|------|------|------|------|------|------|
| DIM | 16.0 | 6.9 | 7.6 | 2.6 | 12.0 | 7.5 | 1.75 | 1.5 | 1.50 | 4.0 | 2.0 | 0.35 |
| Tole | ±0.3 | Typ. | Typ. | Typ. | ±0.1 | ±0.1 | ±0.1 | ±0.1 | ±0.1 | ±0.1 | ±0.1 | Typ. |

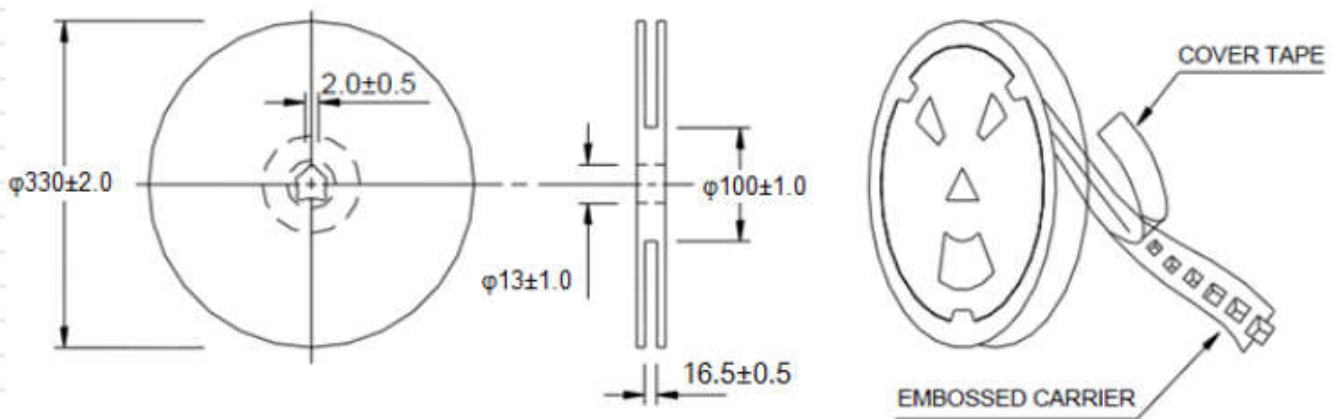
Specification Sheet for SMD Power Inductor

8.2 Taping dimension and taped direction, Leader, Trailer, section dimension



| | |
|-------------------------|------------|
| Leader section | Min. 400mm |
| Carrier tape start size | Min. 150mm |
| Trailer section size | Min. 150mm |

8.3 Reel Dimensions



8.4 Taping Quantity

1500 pieces/Reel,

8.5 Carton

Pizza packaging: 3 Reel/Pizza Box

External Packaging: 3 Boxes/Carton

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [Fixed Inductors](#) category:

Click to view products by [Ceaiya](#) manufacturer:

Other Similar products are found below :

[CR32NP-100KC](#) [70F224AI](#) [MHQ1005P10NJ](#) [MHQ1005P1N0S](#) [MHQ1005P2N4S](#) [MHQ1005P3N6S](#) [MHQ1005P5N1S](#) [MHQ1005P8N2J](#)
[PE-53601NL](#) [PE-53602NL](#) [PG0936.113NLT](#) [9220-20](#) [9310-16](#) [PM06-2N7](#) [PM06-39NJ](#) [A01TK](#) [1206CS-471XJ](#) [HC2-R47-R](#) [HC8-1R2-R](#)
[HCF1305-3R3-R](#) [1206CS-151XG](#) [RCH664NP-4R7M](#) [RCP1317NP-391L](#) [DH2280-4R7M](#) [DS1608C-106](#) [B10TJ](#) [B82498B3101J000](#) [ELJ-](#)
[RE27NJF2](#) [1812CS-153XJ](#) [1812CS-183XJ](#) [1812CS-223XJ](#) [1812LS-104XJ](#) [1812LS-105XJ](#) [1812LS-124XJ](#) [1812LS-154XJ](#) [1812LS-223XJ](#)
[1812LS-224XJ](#) [1812LS-563XJ](#) [1812LS-683XJ](#) [1812LS-824XJ](#) [NIN-FB101JTR110F](#) [NIN-FB471JTR62F](#) [NIN-FC1R5JTR220F](#) [NIN-](#)
[HCR15JTRF](#) [NIN-HCR33JTRF](#) [NIN-HDR22JTRF](#) [NIN-HDR82JTRF](#) [NIN-HK2N7STRF](#) [NIN-PA150KTR370F](#) [NIN-PB100KTR550F](#)